Microchip Technology - DSPIC33CH64MP502-E/2N Datasheet

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit Dual-Core
Speed	180MHz, 200MHz
Connectivity	CANbus, I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, QEI, WDT
Number of I/O	21
Program Memory Size	88KB (88K x 8)
Program Memory Type	FLASH, PRAM
EEPROM Size	-
RAM Size	20K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 23x12b; D/A 4x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-UQFN Exposed Pad
Supplier Device Package	28-UQFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ch64mp502-e-2n

3.0 MASTER MODULES

3.1 Master CPU

Note 1: This data sheet summarizes the features of the dsPIC33CH128MP508 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"dsPIC33E Enhanced CPU"** (DS70005158) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

There are two independent CPU cores in the dsPIC33CH128MP508 family. The Master and Slave cores are similar, except for the fact that the Slave core can run at a higher speed than the Master core.

The Slave core fetches instructions from the PRAM and the Master core fetches the code from the Flash. The Master and Slave cores can run independently asynchronously, at the same speed or at a different speed. This section discusses the Master core.

Note: All of the associated register names are the same on the Master, as well as on the Slave. The Slave code will be developed in a separate project in MPLAB® X IDE with the device selection, dsPIC33CH128MP508**S1**, where the **S1** indicates the Slave device.

The dsPIC33CH128MP508 family CPU has a 16-bit (data) modified Harvard architecture with an enhanced instruction set, including significant support for Digital Signal Processing (DSP). The CPU has a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M x 24 bits of user program memory space.

An instruction prefetch mechanism helps maintain throughput and provides predictable execution. Most instructions execute in a single-cycle effective execution rate, with the exception of instructions that change the program flow, the double-word move (`MOV.D`) instruction, PSV accesses and the table instructions. Overhead-free program loop constructs are supported using the `DO` and `REPEAT` instructions, both of which are interruptible at any point.

3.1.1 REGISTERS

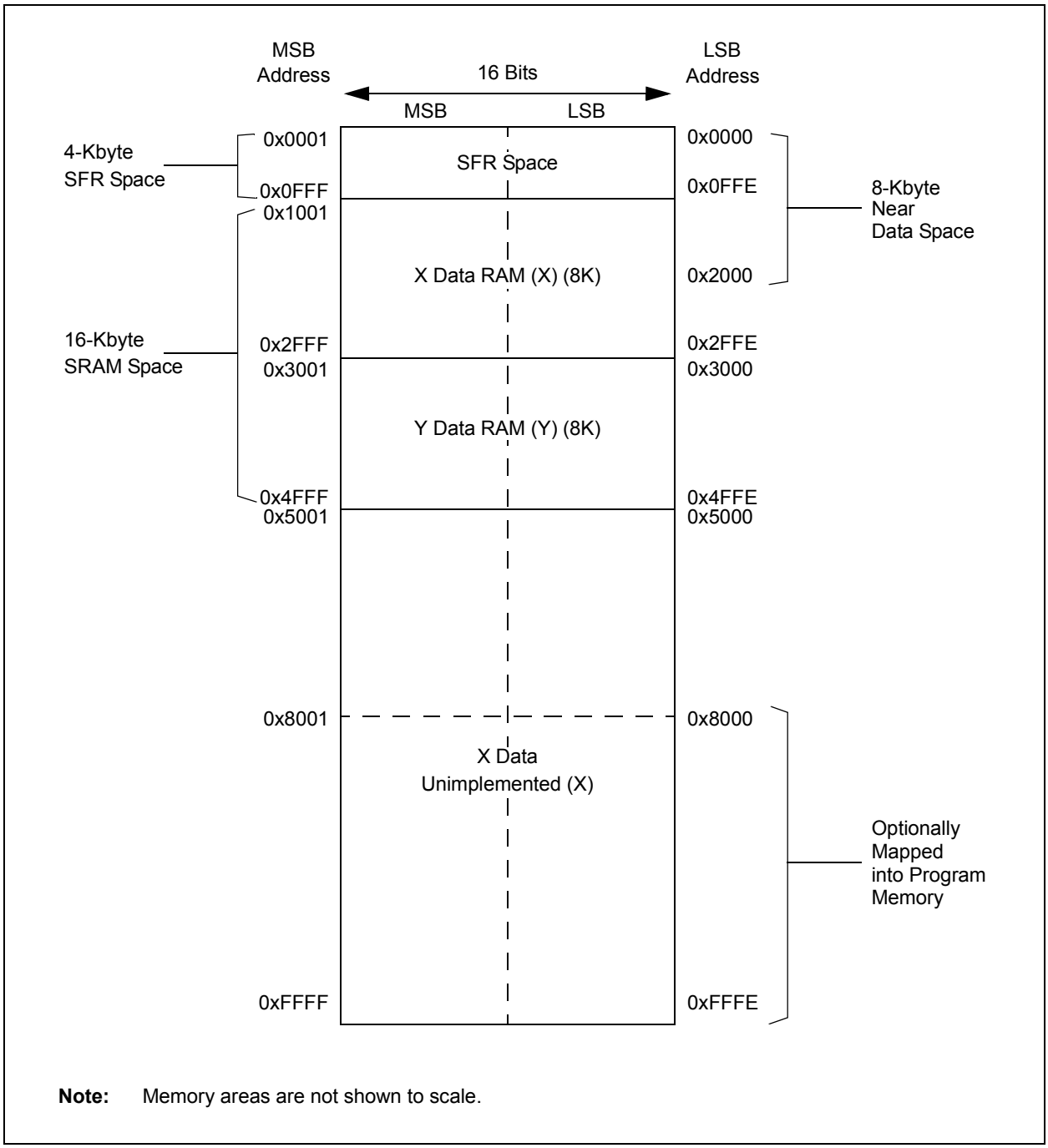
The dsPIC33CH128MP508 devices have sixteen, 16-bit Working registers in the programmer's model. Each of the Working registers can act as a Data, Address or Address Offset register. The 16th Working register (W15) operates as a Software Stack Pointer for interrupts and calls.

In addition, the dsPIC33CH128MP508 devices include four Alternate Working register sets, which consist of W0 through W14. The Alternate Working registers can be made persistent to help reduce the saving and restoring of register content during Interrupt Service Routines (ISRs). The Alternate Working registers can be assigned to a specific Interrupt Priority Level (IPL1 through IPL7) by configuring the CTXTx<2:0> bits in the FALTREG Configuration register. The Alternate Working registers can also be accessed manually by using the `CTXTSWP` instruction. The CCTXI<2:0> and MCTXI<2:0> bits in the CTXTSTAT register can be used to identify the current, and most recent, manually selected Working register sets.

3.1.2 INSTRUCTION SET

The instruction set for dsPIC33CH128MP508 devices has two classes of instructions: the MCU class of instructions and the DSP class of instructions. These two instruction classes are seamlessly integrated into the architecture and execute from a single execution unit. The instruction set includes many addressing modes and was designed for optimum C compiler efficiency.

FIGURE 3-6: DATA MEMORY MAP FOR dsPIC33CH128MP508 DEVICES



Note: Memory areas are not shown to scale.

FIGURE 3-11: BIT-REVERSED ADDRESSING EXAMPLE

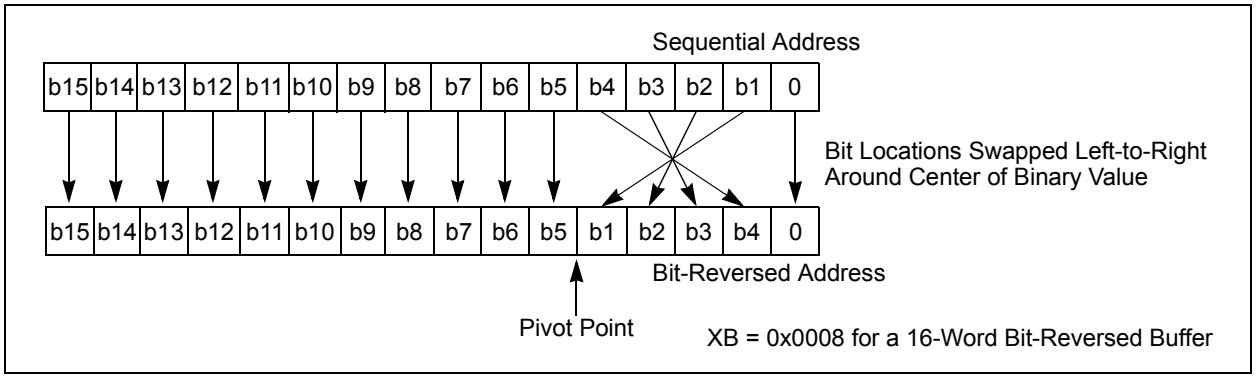


TABLE 3-21: BIT-REVERSED ADDRESSING SEQUENCE (16-ENTRY)

Normal Address					Bit-Reversed Address				
A3	**A2**	**A1**	**A0**	**Decimal**	**A3**	**A2**	**A1**	**A0**	**Decimal**
0	0	0	0	0	0	0	0	0	0
0	0	0	1	1	1	0	0	0	8
0	0	1	0	2	0	1	0	0	4
0	0	1	1	3	1	1	0	0	12
0	1	0	0	4	0	0	1	0	2
0	1	0	1	5	1	0	1	0	10
0	1	1	0	6	0	1	1	0	6
0	1	1	1	7	1	1	1	0	14
1	0	0	0	8	0	0	0	1	1
1	0	0	1	9	1	0	0	1	9
1	0	1	0	10	0	1	0	1	5
1	0	1	1	11	1	1	0	1	13
1	1	0	0	12	0	0	1	1	3
1	1	0	1	13	1	0	1	1	11
1	1	1	0	14	0	1	1	1	7
1	1	1	1	15	1	1	1	1	15

REGISTER 3-5: NVMADR: NONVOLATILE MEMORY LOWER ADDRESS REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
NVMADR<15:8>							
bit 15							bit 8

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
NVMADR<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **NVMADR<15:0>:** Nonvolatile Memory Lower Write Address bits
Selects the lower 16 bits of the location to program or erase in Program Flash Memory. This register may be read or written to by the user application.

REGISTER 3-6: NVMADRU: NONVOLATILE MEMORY UPPER ADDRESS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
NVMADRU<23:16>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 **NVMADRU<23:16>:** Nonvolatile Memory Upper Write Address bits
Selects the upper 8 bits of the location to program or erase in Program Flash Memory. This register may be read or written to by the user application.

REGISTER 3-53: RPINR19: PERIPHERAL PIN SELECT INPUT REGISTER 19

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
U2DSRR7	U2DSRR6	U2DSRR5	U2DSRR4	U2DSRR3	U2DSRR2	U2DSRR1	U2DSRR0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
U2RXR7	U2RXR6	U2RXR5	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **U2DSRR<7:0>:** Assign UART2 Data-Set-Ready ($\overline{\text{U2DSR}}$) to the Corresponding RPn Pin bits
See Table 3-30.

bit 7-0 **U2RXR<7:0>:** Assign UART2 Receive (U2RX) to the Corresponding RPn Pin bits
See Table 3-30.

REGISTER 3-54: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SCK1R7	SCK1R6	SCK1R5	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SDI1R7	SDI1R6	SDI1R5	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **SCK1R<7:0>:** Assign SPI1 Clock Input (SCK1IN) to the Corresponding RPn Pin bits
See Table 3-30.

bit 7-0 **SDI1R<7:0>:** Assign SPI1 Data Input (SDI1) to the Corresponding RPn Pin bits
See Table 3-30.

REGISTER 3-74: RPOR6: PERIPHERAL PIN SELECT OUTPUT REGISTER 6

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP45R5	RP45R4	RP45R3	RP45R2	RP45R1	RP45R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP44R5	RP44R4	RP44R3	RP44R2	RP44R1	RP44R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP45R<5:0>:** Peripheral Output Function is Assigned to RP45 Output Pin bits (see Table 3-33 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP44R<5:0>:** Peripheral Output Function is Assigned to RP44 Output Pin bits (see Table 3-33 for peripheral function numbers)

REGISTER 3-75: RPOR7: PERIPHERAL PIN SELECT OUTPUT REGISTER 7

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP47R5	RP47R4	RP47R3	RP47R2	RP47R1	RP47R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP46R5	RP46R4	RP46R3	RP46R2	RP46R1	RP46R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP47R<5:0>:** Peripheral Output Function is Assigned to RP47 Output Pin bits (see Table 3-33 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP46R<5:0>:** Peripheral Output Function is Assigned to RP46 Output Pin bits (see Table 3-33 for peripheral function numbers)

REGISTER 3-99: DMTPSINTVL: DMT POST-CONFIGURE INTERVAL STATUS REGISTER LOW

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PSINTV<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PSINTV<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PSINTV<15:0>:** Lower DMT Window Interval Configuration Status bits
This is always the value of the FDMTIVTL Configuration register.

REGISTER 3-100: DMTPSINTVH: DMT POST-CONFIGURE INTERVAL STATUS REGISTER HIGH

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PSINTV<31:24>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PSINTV<23:16>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PSINTV<31:16>:** Higher DMT Window Interval Configuration Status bits
This is always the value of the FDMTIVTH Configuration register.

REGISTER 3-114: C1VECH: CAN INTERRUPT CODE REGISTER HIGH

U-0	R-1	R-0	R-0	R-0	R-0	R-0	R-0
—	RXCODE<6:0>						
bit 15							bit 8

U-0	R-1	R-0	R-0	R-0	R-0	R-0	R-0
—	TXCODE<6:0>						
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-8 **RXCODE<6:0>:** Receive Interrupt Flag Code bits
1000001-1111111 = Reserved
1000000 = No interrupt
0001000-0111111 = Reserved
0000111 = FIFO 7 interrupt (RFIF7 is set)
...
0000010 = FIFO 2 interrupt (RFIF2 is set)
0000001 = FIFO 1 interrupt (RFIF1 is set)
0000000 = Reserved; FIFO 0 cannot receive

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **TXCODE<6:0>:** Transmit Interrupt Flag Code bits
1000001-1111111 = Reserved
1000000 = No interrupt
0001000-0111111 = Reserved
0000111 = FIFO 7 interrupt (TFIF7 is set)
...
0000001 = FIFO 1 interrupt (TFIF1 is set)
0000000 = FIFO 0 interrupt (TFIF0 is set)

REGISTER 3-159: ADCON2L: ADC CONTROL REGISTER 2 LOW

R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
REFCIE	REFERCIE	—	EIEN	—	SHREISEL2(1)	SHREISEL1(1)	SHREISEL0(1)
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	SHRADCS6	SHRADCS5	SHRADCS4	SHRADCS3	SHRADCS2	SHRADCS1	SHRADCS0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **REFCIE:** Band Gap and Reference Voltage Ready Common Interrupt Enable bit
1 = Common interrupt will be generated when the band gap becomes ready
0 = Common interrupt is disabled for the band gap ready event

bit 14 **REFERCIE:** Band Gap or Reference Voltage Error Common Interrupt Enable bit
1 = Common interrupt will be generated when a band gap or reference voltage error is detected
0 = Common interrupt is disabled for the band gap and reference voltage error event

bit 13 **Unimplemented:** Read as '0'

bit 12 **EIEN:** Early Interrupts Enable bit
1 = The early interrupt feature is enabled for the input channel interrupts (when the EISTATx flag is set)
0 = The individual interrupts are generated when conversion is done (when the ANxRDY flag is set)

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **SHREISEL<2:0>:** Shared Core Early Interrupt Time Selection bits(1)
111 = Early interrupt is set and interrupt is generated 8 TADCORE clocks prior to when the data is ready
110 = Early interrupt is set and interrupt is generated 7 TADCORE clocks prior to when the data is ready
101 = Early interrupt is set and interrupt is generated 6 TADCORE clocks prior to when the data is ready
100 = Early interrupt is set and interrupt is generated 5 TADCORE clocks prior to when the data is ready
011 = Early interrupt is set and interrupt is generated 4 TADCORE clocks prior to when the data is ready
010 = Early interrupt is set and interrupt is generated 3 TADCORE clocks prior to when the data is ready
001 = Early interrupt is set and interrupt is generated 2 TADCORE clocks prior to when the data is ready
000 = Early interrupt is set and interrupt is generated 1 TADCORE clock prior to when the data is ready

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **SHRADCS<6:0>:** Shared ADC Core Input Clock Divider bits
These bits determine the number of TCORESRC (Source Clock Periods) for one shared TADCORE (Core Clock Period).
1111111 = 254 Source Clock Periods
...
0000011 = 6 Source Clock Periods
0000010 = 4 Source Clock Periods
0000001 = 2 Source Clock Periods
0000000 = 2 Source Clock Periods

Note 1: For the 6-bit shared ADC core resolution (SHRRES<1:0> = 00), the SHREISEL<2:0> settings, from '100' to '111', are not valid and should not be used. For the 8-bit shared ADC core resolution (SHRRES<1:0> = 01), the SHREISEL<2:0> settings, '110' and '111', are not valid and should not be used.

4.2.8.1 Data Access from Program Memory Using Table Instructions

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the Program Space without going through Data Space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper eight bits of a Program Space word as data.

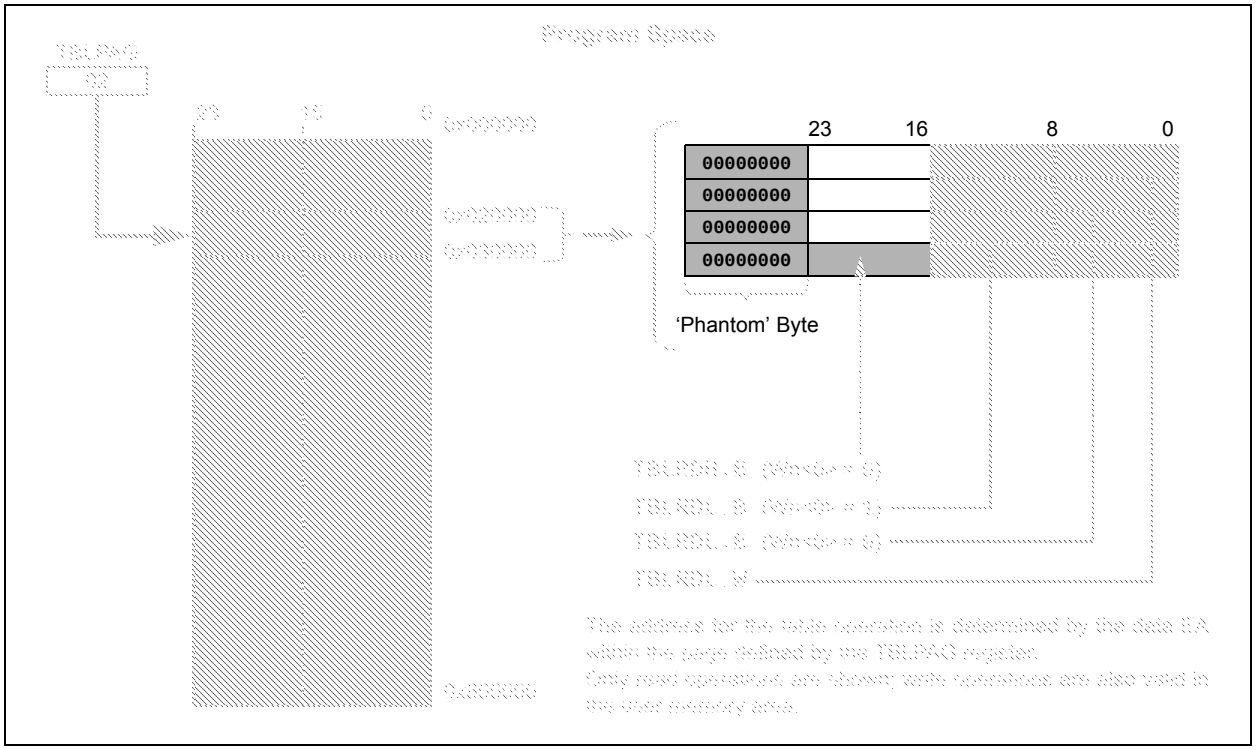
This allows program memory addresses to directly map to Data Space addresses. Program memory can thus be regarded as two 16-bit wide word address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space that contains the least significant data word. TBLRDH and TBLWTH access the space that contains the upper data byte.

Two table instructions are provided to read byte or word-sized (16-bit) data from Program Space. Both function as either byte or word operations.

- TBLRDL (Table Read Low):
  - In Word mode, this instruction maps the lower word of the Program Space location (P<15:0>) to a data address (D<15:0>).
  - In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'.
- TBLRDH (Table Read High):
  - In Word mode, this instruction maps the entire upper word of a program address (P<23:16>) to a data address. The 'phantom' byte (D<15:8>) is always '0'.
  - In Byte mode, either the upper or lower byte of the upper program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'. When the upper byte is selected, the 'phantom' byte is read as '0'.

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a Program Space address. For these writes, data is written to a set of NVM latches and subsequently copied to the Program Space address using an NVM write operation. The details of their operation are explained in **Section 4.3.2 "RTSP Operation"**.

FIGURE 4-12: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS



REGISTER 4-47: RPINR15: PERIPHERAL PIN SELECT INPUT REGISTER 15

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
QEIHOM1R7	QEIHOM1R6	QEIHOM1R5	QEIHOM1R4	QEIHOM1R3	QEIHOM1R2	QEIHOM1R1	QEIHOM1R0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
QEINDX1R7	QEINDX1R6	QEINDX1R5	QEINDX1R4	QEINDX1R3	QEINDX1R2	QEINDX1R1	QEINDX1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **QEIHOM1R<7:0>:** Assign QEI Home 1 Input (S1QEIHOM1) to the Corresponding S1RPn Pin bits See Table 4-27.

bit 7-0 **QEINDX1R<7:0>:** Assign QEI Index 1 Input (S1QEINDX1) to the Corresponding S1RPn Pin bits See Table 4-27.

REGISTER 4-48: RPINR18: PERIPHERAL PIN SELECT INPUT REGISTER 18

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
U1DSRR7	U1DSRR6	U1DSRR5	U1DSRR4	U1DSRR3	U1DSRR2	U1DSRR1	U1DSRR0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
U1RXR7	U1RXR6	U1RXR5	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **U1DSRR<7:0>:** Assign UART1 Data-Set-Ready ($\overline{\text{S1U1DSR}}$) to the Corresponding S1RPn Pin bits See Table 4-27.

bit 7-0 **U1RXR<7:0>:** Assign UART1 Receive (S1U1RX) to the Corresponding S1RPn Pin bits See Table 4-27.

REGISTER 9-27: PGxTRIGA: PWM GENERATOR x TRIGGER A REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PGxTRIGA<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PGxTRIGA<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PGxTRIGA<15:0>:** PWM Generator x Trigger A Register bits

REGISTER 9-28: PGxTRIGB: PWM GENERATOR x TRIGGER B REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PGxTRIGB<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PGxTRIGB<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PGxTRIGB<15:0>:** PWM Generator x Trigger B Register bits

REGISTER 9-29: PGxTRIGC: PWM GENERATOR x TRIGGER C REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PGxTRIGC<15:8>							
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PGxTRIGC<7:0>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-0 **PGxTRIGC<15:0>:** PWM Generator x Trigger C Register bits

REGISTER 10-3: CCPxCON2L: CCPx CONTROL 2 LOW REGISTERS

R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0
PWMRSEN	ASDGM	—	SSDG	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ASDG7	ASDG6	ASDG5	ASDG4	ASDG3	ASDG2	ASDG1	ASDG0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **PWMRSEN:** CCPx PWM Restart Enable bit
- 1 = ASEVT bit clears automatically at the beginning of the next PWM period, after the shutdown input has ended
- 0 = ASEVT bit must be cleared in software to resume PWM activity on output pins

bit 14 **ASDGM:** CCPx Auto-Shutdown Gate Mode Enable bit
- 1 = Waits until the next Time Base Reset or rollover for shutdown to occur
- 0 = Shutdown event occurs immediately

bit 13 **Unimplemented:** Read as '0'

bit 12 **SSDG:** CCPx Software Shutdown/Gate Control bit
- 1 = Manually forces auto-shutdown, timer clock gate or input capture signal gate event (setting of ASDGM bit still applies)
- 0 = Normal module operation

bit 11-8 **Unimplemented:** Read as '0'

bit 7-0 **ASDG<7:0>:** CCPx Auto-Shutdown/Gating Source Enable bits
- 1 = ASDGx Source n is enabled (see Table 10-8 and Table 10-9 for auto-shutdown/gating sources)
- 0 = ASDGx Source n is disabled

14.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note 1: This data sheet summarizes the features of the dsPIC33CH128MP508 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Serial Peripheral Interface (SPI) with Audio Codec Support"** (DS70005136) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: The SPI is Identical for both Master core and Slave core. The x is common for both Master and Slave (where the x represents the number of the specific module being addressed). The number of SPI modules available on the Master and Slave is different and they are located in different SFR locations.

3: All associated register names are the same on the Master core and the Slave core. The Slave code will be developed in a separate project in MPLAB® X IDE with the device selection, dsPIC33CH128MP508**S1**, where the **S1** indicates the Slave device. The Master is SPI1 and SPI2, and the Slave is SPI1.

Table 14-1 shows an overview of the SPI module.

TABLE 14-1: SPI MODULE OVERVIEW

	Number of SPI Modules	Identical (Modules)
Master Core	2	Yes
Slave Core	1	Yes

The Serial Peripheral Interface (SPI) module is a synchronous serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SPI module is compatible with the Motorola® SPI and SIOP interfaces. All devices in the dsPIC33CH128MP508 family include three SPI modules; two SPIs for the Master core and one for the Slave core. One of the SPI modules can work up to 50 MHz speed when selected as a non-PPS pin. For the Master core, it will be SPI2 and for the Slave core, it will be SPI1. The selection is done using the SPI2PIN bit (FDEVOPT<13>) for the Master and the S1SPI1PIN bit (FS1DEVOPT<13>) for the Slave. If the bit for SPI2PIN/S1SPI1PIN is '1', the PPS pin will be used. If the SPI2PIN/S1SPI1PIN is '0', it will use the dedicated SPI pads.

The module supports operation in two Buffer modes. In Standard mode, data is shifted through a single serial buffer. In Enhanced Buffer mode, data is shifted through a FIFO buffer. The FIFO level depends on the configured mode.

Note: FIFO depth for this device is four (in 8-Bit Data mode).

Variable length data can be transmitted and received, from 2 to 32 bits.

Note: Do not perform Read-Modify-Write operations (such as bit-oriented instructions) on the SPIxBUF register in either Standard or Enhanced Buffer mode.

The module also supports a basic framed SPI protocol while operating in either Master or Slave mode. A total of four framed SPI configurations are supported.

The module also supports Audio modes. Four different Audio modes are available.

- I^2S mode
- Left Justified mode
- Right Justified mode
- PCM/DSP mode

In each of these modes, the serial clock is free-running and audio data is always transferred.

If an audio protocol data transfer takes place between two devices, then usually one device is the Master and the other is the Slave. However, audio data can be transferred between two Slaves. Because the audio protocols require free-running clocks, the Master can be a third-party controller. In either case, the Master generates two free-running clocks: SCKx and LRC (Left, Right Channel Clock/$\overline{SS}$x/FSYNC).

The SPI serial interface consists of four pins:

- SDIx/S1SDIx: Serial Data Input
- SDOx/S1SDOx: Serial Data Output
- SCKx/S1SCKx: Shift Clock Input or Output
- $\overline{SS}$x/$\overline{S1SS}$x: Active-Low Slave Select or Frame Synchronization I/O Pulse

The SPI module can be configured to operate using two, three or four pins. In the 3-pin mode, $\overline{SS}$x/$\overline{S1SS}$x is not used. In the 2-pin mode, both SDOx/S1SDOx and $\overline{SS}$x/$\overline{S1SS}$x are not used.

REGISTER 21-2: FBSLIM CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

U-1	U-1	U-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
—	—	—	BSLIM<12:8>				
bit 15							bit 8

R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1	R/PO-1
BSLIM<7:0>							
bit 7							bit 0

Legend:	PO = Program Once bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 23-13 **Unimplemented:** Read as ‘1’

bit 12-0 **BSLIM<12:0>:** Boot Segment Code Flash Page Address Limit bits

Contains the page address of the first active General Segment page. The value to be programmed is the inverted page address, such that programming additional ‘0’s can only increase the Boot Segment size.

REGISTER 21-3: FSIGN CONFIGURATION REGISTER

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 23							bit 16

r-0	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 15							bit 8

U-1	U-1	U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:	r = Reserved bit	PO = Program Once bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 23-16 **Unimplemented:** Read as ‘1’

bit 15 **Reserved:** Maintain as ‘0’

bit 14-0 **Unimplemented:** Read as ‘1’

21.7 Dual Watchdog Timer (WDT)

Note 1: This data sheet summarizes the features of the dsPIC33CH128MP508 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"Dual Watchdog Timer",** (DS70005250) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

2: The WDT is identical for both Master core and Slave core. The x is common for both Master core and Slave core (where the x represents the number of the specific module being addressed). The number of WDT modules available on the Master and Slaves is different and they are located in different SFR locations.

3: All associated register names are the same on the Master core and the Slave core. The Slave code will be developed in a separate project in MPLAB® X IDE with the device selection, dsPIC33CH128MP508**S1**, where the **S1** indicates the Slave device.

Table 21-6 shows an overview of the WDT module.

TABLE 21-6: DUAL WDT MODULE OVERVIEW

	Number of WDT Modules	Identical (Modules)
Master Core	1	Yes
Slave Core	1	Yes

The dsPIC33 dual Watchdog Timer (WDT) is described in this section. Refer to Figure 21-2 for a block diagram of the WDT.

The WDT, when enabled, operates from the internal Low-Power RC (LPRC) Oscillator clock source or a selectable clock source in Run mode. The WDT can be used to detect system software malfunctions by resetting the device if the WDT is not cleared periodically in software. The WDT can be configured in Windowed mode or Non-Windowed mode. Various WDT time-out periods can be selected using the WDT postscaler. The WDT can also be used to wake the device from Sleep or Idle mode (Power Save mode). If the WDT expires and issues a device Reset, the WTDO bit of the RCON register (Register 21-37) will be set.

The following are some of the key features of the WDT modules:

- Configuration or Software Controlled
- Separate User-Configurable Time-out Periods for Run and Sleep/Idle
- Can Wake the Device from Sleep or Idle
- User-Selectable Clock Source in Run mode
- Operates from LPRC in Sleep/Idle mode

Note: While executing a clock switch, the WDT will not be reset. It is recommended to reset the WDT prior to executing a clock switch instruction.

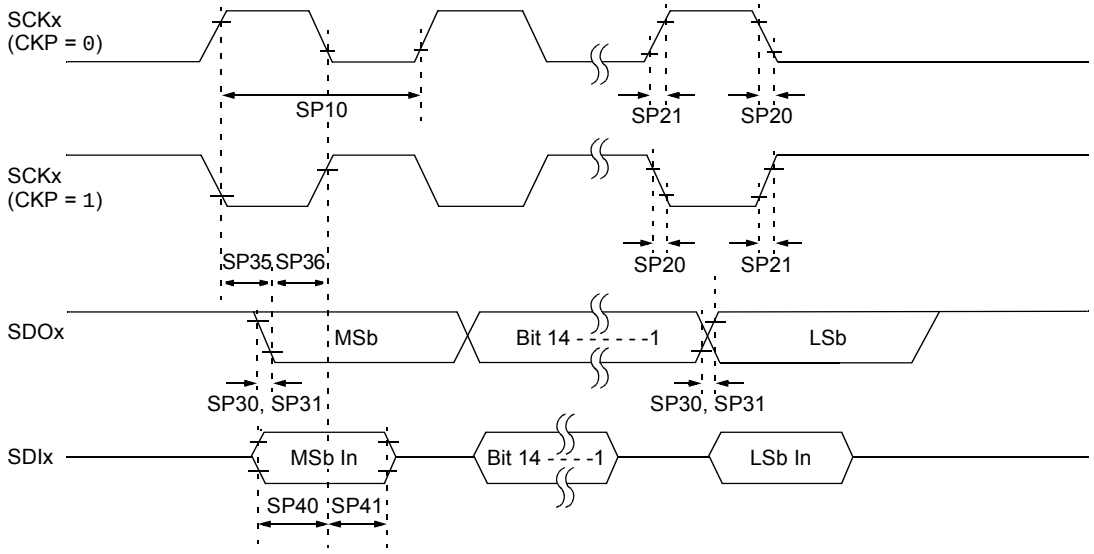
TABLE 24-7: DC CHARACTERISTICS: OPERATING CURRENT (IDD) (MASTER RUN/SLAVE SLEEP)

DC CHARACTERISTICS	Master (Run) + Slave (Sleep)		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typ.**	**Max.**	**Units**	**Conditions**		
Operating Current (IDD)(1)						
DC20b	7.9	9.8	mA	-40°C	3.3V	10 MIPS (N = 1, N2 = 5, N3 = 2, M = 50, FVCO = 400 MHz, FPLLO = 40 MHz)
	8.0	13.4	mA	+25°C		
	8.2	19.5	mA	+85°C		
	12.2	26.3	mA	+125°C		
DC21b	10.3	12.4	mA	-40°C	3.3V	20 MIPS (N = 1, N2 = 5, N3 = 1, M = 50, FVCO = 400 MHz, FPLLO = 80 MHz)
	10.5	16.0	mA	+25°C		
	10.6	22.1	mA	+85°C		
	14.6	28.7	mA	+125°C		
DC22b	14.2	16.5	mA	-40°C	3.3V	40 MIPS (N = 1, N2 = 3, N3 = 1, M = 60, FVCO = 480 MHz, FPLLO = 160 MHz)
	14.4	20.3	mA	+25°C		
	14.5	26.3	mA	+85°C		
	18.4	32.6	mA	+125°C		
DC23b	22.3	25.4	mA	-40°C	3.3V	70 MIPS (N = 1, N2 = 2, N3 = 1, M = 70, FVCO = 560 MHz, FPLLO = 280 MHz)
	22.5	29.4	mA	+25°C		
	22.4	34.9	mA	+85°C		
	26.4	40.7	mA	+125°C		
DC24b	25.6	29.0	mA	-40°C	3.3V	90 MIPS (N = 1, N2 = 2, N3 = 1, M = 90, FVCO = 720 MHz, FPLLO = 360 MHz)
	25.8	33.1	mA	+25°C		
	25.7	38.2	mA	+85°C		
	29.4	43.8	mA	+125°C		

Note 1: IDD is primarily a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDD measurements are as follows:

- FIN = 8 MHz, FPFD = 8 MHz
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as output low
- $\overline{\text{MCLR}}$ = VDD, WDT and FSCM are disabled
- CPU, SRAM, program memory and data memory are operational
- No peripheral modules are operating or being clocked (all defined PMDx bits are set)
- CPU is executing `while(1)` statement
- JTAG is disabled

FIGURE 24-10: SPIx MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING CHARACTERISTICS



Note: Refer to Figure 24-1 for load conditions.

TABLE 24-37: SPIx MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min.**	**Typ.(2)**	**Max.**	**Units**	**Conditions**
SP10	FscP	Maximum SCKx Frequency	—	—	15	MHz	Using PPS pins
			—	—	40	MHz	SPI2 dedicated pins
SP20	TscF	SCKx Output Fall Time	—	—	—	ns	See Parameter DO32 **(Note 3)**
SP21	TscR	SCKx Output Rise Time	—	—	—	ns	See Parameter DO31 **(Note 3)**
SP30	TdoF	SDOx Data Output Fall Time	—	—	—	ns	See Parameter DO32 **(Note 3)**
SP31	TdoR	SDOx Data Output Rise Time	—	—	—	ns	See Parameter DO31 **(Note 3)**
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid After SCKx Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	—	—	ns	Using PPS pins
			20	—	—	ns	SPI2 dedicated pins
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	30	—	—	ns	Using PPS pins
			10	—	—	ns	SPI2 dedicated pins
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	—	—	ns	Using PPS pins
			15	—	—	ns	SPI2 dedicated pins

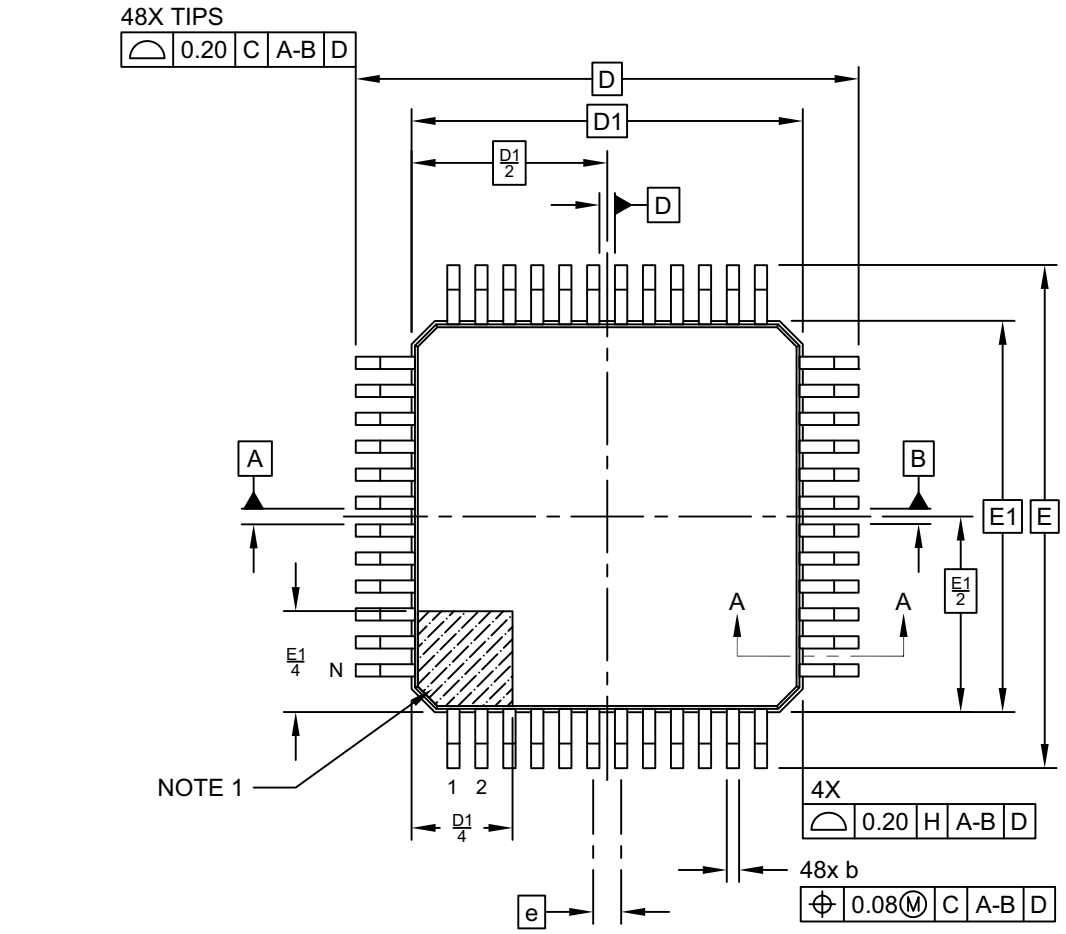
Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ." column is at 3.3V, +25°C unless otherwise stated.

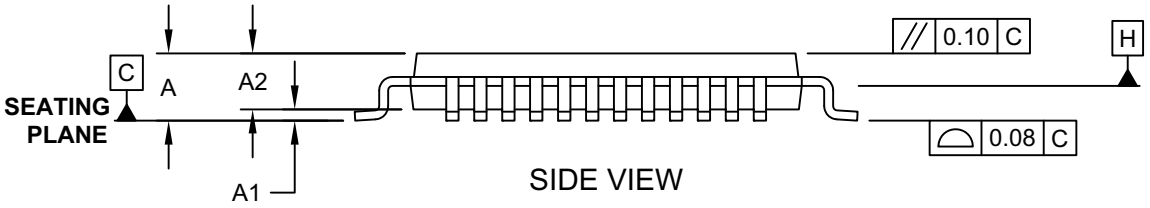
3: Assumes 50 pF load on all SPIx pins.

48-Lead Thin Quad Flatpack (PT) - 7x7x1.0 mm Body [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW

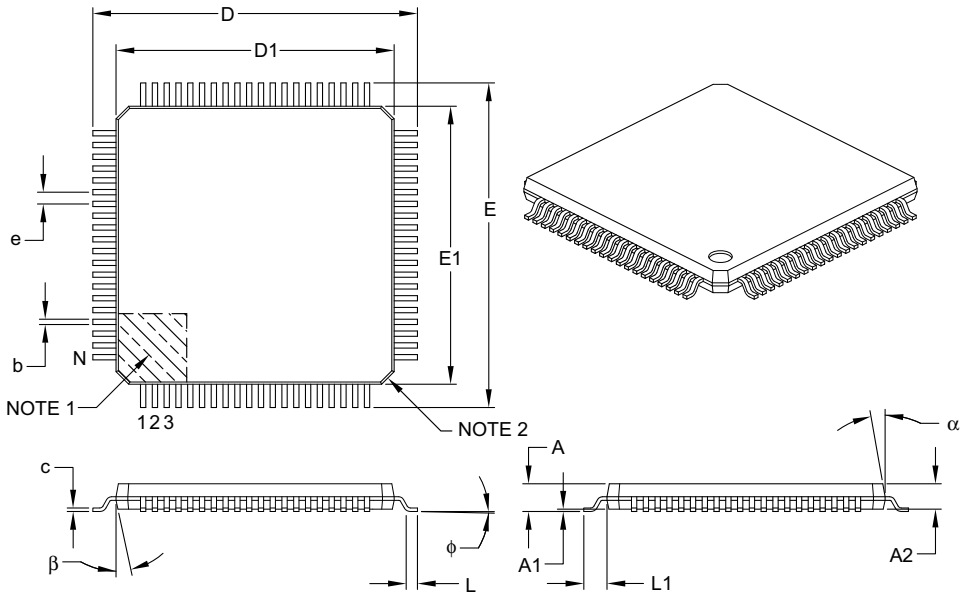


SIDE VIEW

Microchip Technology Drawing C04-300-PT Rev A Sheet 1 of 2

80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		80	
Lead Pitch	e		0.50 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ϕ	0°	3.5°	7°
Overall Width	E		14.00 BSC	
Overall Length	D		14.00 BSC	
Molded Package Width	E1		12.00 BSC	
Molded Package Length	D1		12.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-092B